1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in Trench MOSFET technology and NPN Resistor-Equipped Transistor (RET) together in a leadless medium power DFN2020-6 (SOT1118) Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Trench MOSFET technology
- NPN transistor built-in bias resistors
- Small and leadless ultra thin SMD plastic package: 2 x 2 x 0.65 mm
- Exposed drain pad for excellent thermal conduction

3. Applications

- Charging switch for portable devices
- High-side load switch
- USB port overvoltage protection
- Power management in battery-driven portables
- Hard disk and computing power management

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit			
P-channel Tre	P-channel Trench MOSFET									
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	-30	V			
V_{GS}	gate-source voltage			-12	-	12	V			
I _D	drain current	$V_{GS} = -4.5 \text{ V}; T_{amb} = 25 \text{ °C}; t \le 5 \text{ s}$	[1]	-	-	-3.4	Α			
P-channel Tre	P-channel Trench MOSFET; static characteristics									
R _{DSon}	drain-source on-state resistance	V_{GS} = -4.5 V; I_D = -2.6 A; T_j = 25 °C		-	85	110	mΩ			
NPN RET										
V _{CEO}	collector-emitter voltage	T _{amb} = 25 °C; open base		-	-	50	V			
I _O	output current			-	-	100	mA			



30 V P-channel MOSFET with pre-biased NPN transistor

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
NPN RET						
R1	bias resistor 1		3.3	4.7	6.1	kΩ
R2	bias resistor 2		-	47	-	kΩ

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm²

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E	emitter	6 5 4	C G S
2	В	base		
3	D	drain	7 8	
4	S	source		R2 R1
5	G	gate	1 2 3	
6	С	collector	Transparent top view DFN2020-6 (SOT1118)	E B D 017aaa396
7	С	collector	DI 142020-0 (3011110)	017888390
8	D	drain		

6. Ordering information

Table 3. Ordering information

Type number	Package	Package					
	Name	Description	Version				
PMC85XP	DFN2020-6	plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals; body 2 x 2 x 0.65 mm	SOT1118				

7. Marking

Table 4. Marking codes

Type number	Marking code
PMC85XP	1K

PMC85XP

30 V P-channel MOSFET with pre-biased NPN transistor

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
P-channel	Trench MOSFET		_			
V_{DS}	drain-source voltage	T _j = 25 °C		-	-30	V
V_{GS}	gate-source voltage			-12	12	V
I _D	drain current	V _{GS} = -4.5 V; T _{amb} = 25 °C; t ≤ 5 s	[1]	-	-3.4	Α
		V _{GS} = -4.5 V; T _{amb} = 25 °C	[1]	-	-2.6	Α
		V _{GS} = -4.5 V; T _{amb} = 100 °C	[1]	-	-1.6	Α
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \mu s$		-	-8	Α
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	485	mW
			[1]	-	1170	mW
		T _{sp} = 25 °C	[2]	-	8300	mW
P-channel	Trench MOSFET; source-drain	diode				
Is	source current	T _{amb} = 25 °C	[1]	-	-1.2	Α
NPN RET						
V_{CBO}	collector-base voltage	T _{amb} = 25 °C; open emitter		-	50	V
V_{CEO}	collector-emitter voltage	T _{amb} = 25 °C; open base		-	50	V
V_{EBO}	emitter-base voltage	T _{amb} = 25 °C; open collector		-	10	V
VI	input voltage	positive		-	30	V
		negative		-	-5	V
I _O	output current			-	100	mA
I _{CM}	peak collector current			-	100	mA
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	465	mW
			[1]	-	985	mW
		$T_{sp} = 25 ^{\circ}C$	[2]	-	4160	mW
Per device	}					
Tj	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm²

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^[2] Device mounted on an FR4 PCB, single-sided copper; tin-plated and standard footprint.

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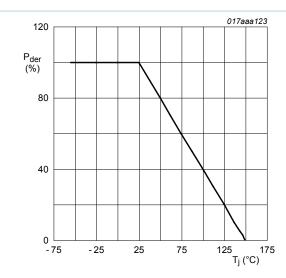


Fig. 1. Normalized total power dissipation as a function of junction temperature

$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100 \%$$

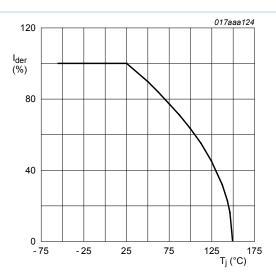


Fig. 2. Normalized continuous drain current as a function of junction temperature

$$I_{der} = \frac{I_D}{I_{D(25^{\circ}C)}} \times 100 \%$$

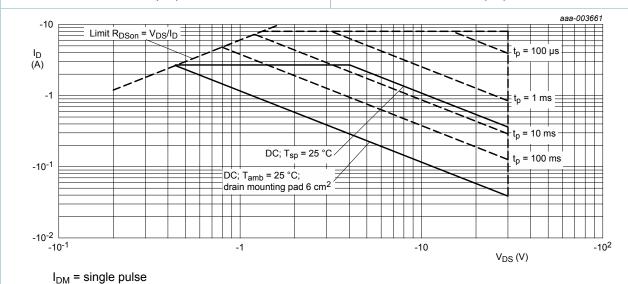


Fig. 3. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drainsource voltage

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
P-channel	P-channel Trench MOSFET							
R _{th(j-a)} thermal resistance	in free air	[1]	-	223	256	K/W		
	from junction to ambient		[2]	-	93	107	K/W	
ambient		t ≤ 5 s; in free air	[2]	-	55	63	K/W	
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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-sp)}	thermal resistance from junction to solder point			-	10	15	K/W
NPN RET			,				
R _{th(j-a)}	thermal resistance	in free air	[1]	-	233	270	K/W
	from junction to ambient		[2]	-	110	127	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	25	30	K/W

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm²

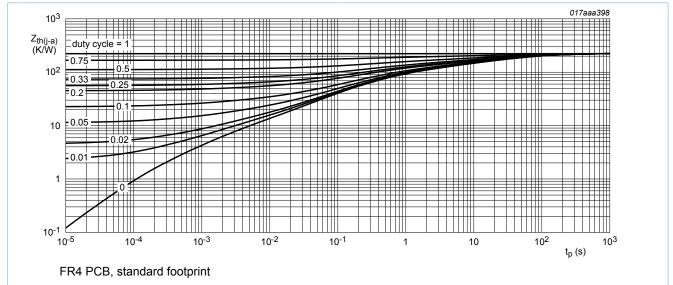


Fig. 4. P-channel Trench MOSFET: Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

30 V P-channel MOSFET with pre-biased NPN transistor

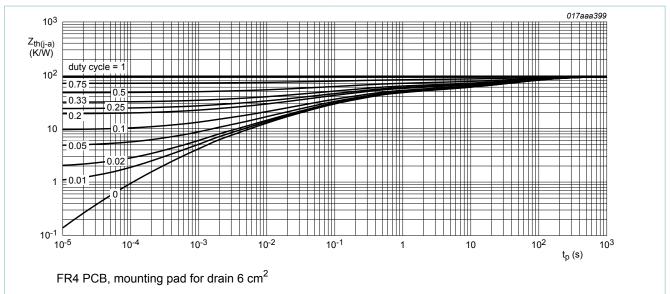


Fig. 5. P-channel Trench MOSFET: Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit			
P-channel	P-channel Trench MOSFET; static characteristics									
V _{(BR)DSS}	drain-source breakdown voltage	$I_D = -250 \mu A; V_{GS} = 0 V; T_j = 25 °C$		-30	-	-	V			
V_{GSth}	gate-source threshold voltage	I_D = -250 mA; V_{DS} = V_{GS} ; T_j = 25 °C		-0.45	-0.78	-1	V			
I _{DSS}	drain leakage current	V_{DS} = -30 V; V_{GS} = 0 V; T_{amb} = 25 °C		-	-	-1	μA			
		V _{DS} = -30 V; V _{GS} = 0 V; T _{amb} = 150 °C		-	-	-11	μA			
I _{GSS}	gate leakage current	V_{GS} = 12 V; V_{DS} = 0 V; T_j = 25 °C		-	-	100	nA			
		V _{GS} = -12 V; V _{DS} = 0 V; T _j = 25 °C		-	-	100	nA			
R _{DSon}	drain-source on-state	V_{GS} = -4.5 V; I_D = -2.6 A; T_j = 25 °C		-	85	110	mΩ			
	resistance	V_{GS} = -4.5 V; I_D = -2.6 A; T_j = 150 °C		-	133	173	mΩ			
		V_{GS} = -2.5 V; I_D = -1.5 A; T_j = 25 °C		-	105	140	mΩ			
9 _{fs}	transfer conductance	V_{DS} = -10 V; I_D = -2.6 A; T_j = 25 °C		-	10	-	S			
P-channel	Trench MOSFET; dynamic	characteristics	1							
Q _{G(tot)}	total gate charge	V_{DS} = -15 V; I_D = -2.6 A; V_{GS} = -4.5 V;		-	5.2	7.8	nC			
Q _{GS}	gate-source charge	$T_j = 25 ^{\circ}\text{C}$		-	1.1	-	nC			
Q_{GD}	gate-drain charge			-	0.95	-	nC			
C _{iss}	input capacitance	V_{DS} = -15 V; f = 1 MHz; V_{GS} = 0 V;		-	680	-	pF			
C _{oss}	output capacitance	T _j = 25 °C		-	54	-	pF			
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30 V P-channel MOSFET with pre-biased NPN transistor

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C _{rss}	reverse transfer capacitance		-	40	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = -15 V; I_{D} = -2.6 A; $R_{G(ext)}$ = 6 Ω ;	-	3	-	ns
t _r	rise time	$V_{GS} = -4.5 \text{ V}; T_j = 25 ^{\circ}\text{C}$	-	15	-	ns
$t_{d(off)}$	turn-off delay time		-	112	-	ns
t _f	fall time		-	48	-	ns
P-channel	Trench MOSFET; source-dr	rain diode				
V _{SD}	source-drain voltage	I_S = -1.2 A; V_{GS} = 0 V; T_j = 25 °C	-	-0.8	-1.2	V
NPN RET			1	1	-	
I _{CBO}	collector-base cut-off current	$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}; T_j = 25 \text{ °C}$	-	-	100	nA
I _{CEO} collector-emitter cut-off	collector-emitter cut-off	V _{CE} = 30 V; I _B = 0 A; T _j = 25 °C	-	-	1	μA
	current	V _{CE} = 30 V; I _B = 0 A; T _j = 150 °C	-	-	50	μA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_C = 0 \text{ A}; T_j = 25 \text{ °C}$	-	-	170	μA
h _{FE}	DC current gain	V_{CE} = 5 V; I_{C} = 10 mA; T_{j} = 25 °C	100	-	-	
V _{CEsat}	collector-emitter saturation voltage	$I_C = 5 \text{ mA}; I_B = 0.25 \text{ mA}; T_j = 25 \text{ °C}$	-	-	100	mV
V _{I(off)}	off-state input voltage	I_C = 100 μ A; V_{CE} = 5 V; T_j = 25 °C	-	0.6	0.5	V
V _{I(on)}	on-state input voltage	I_C = 5 mA; V_{CE} = 0.3 V; T_j = 25 °C	1.3	0.9	-	V
R1	bias resistor 1		3.3	4.7	6.1	kΩ
R2	bias resistor 2		-	47	-	kΩ
R2/R1	bias resistor ratio		8	10	12	
C _C	collector capacitance	$I_E = 0 \text{ A}; i_e = 0 \text{ A}; f = 1 \text{ MHz}; T_j = 25 °C;$ $V_{CB} = 10 \text{ V}$	-	-	2.5	pF

30 V P-channel MOSFET with pre-biased NPN transistor

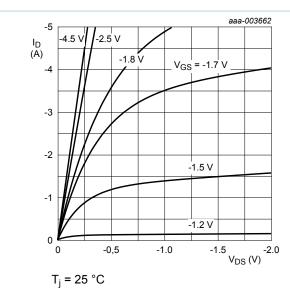
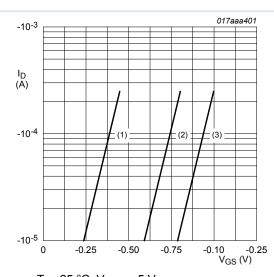


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values



 $T_i = 25 \,^{\circ}\text{C}; \, V_{DS} = -5 \,^{\circ}\text{V}$

- (1) minimum values
- (2) typical values
- (3) maximum values

Fig. 7. Subthreshold drain current as a function of gate-source voltage

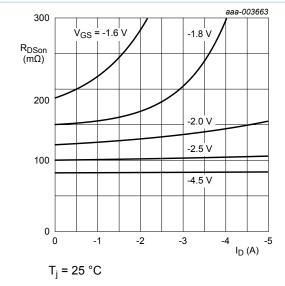


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values

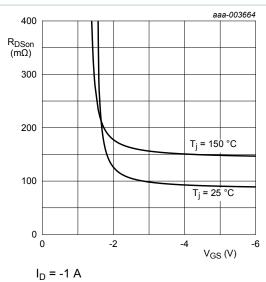
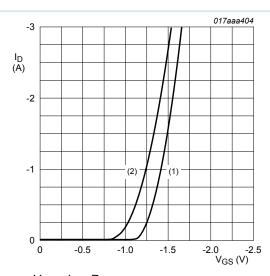


Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values

30 V P-channel MOSFET with pre-biased NPN transistor

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$$V_{DS} > I_{D} \times R_{DSon}$$

(1)
$$T_j = 25 \,^{\circ}C$$

(2)
$$T_i = 150 \, ^{\circ}\text{C}$$

Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

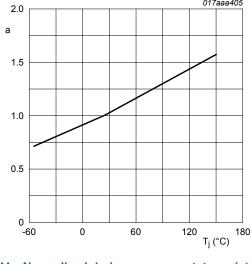
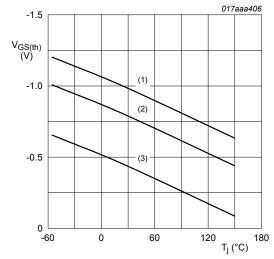


Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values

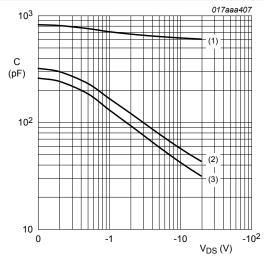
$$a = \frac{R_{DSon}}{R_{DSon(25^{\circ}C)}}$$



 I_D = -0.25 mA; V_{DS} = V_{GS}

- (1) maximum values
- (2) typical values
- (3) minimum values

Fig. 12. Gate-source threshold voltage as a function of junction temperature



 $f = 1 MHz; V_{GS} = 0 V$

- $(1) C_{iss}$
- (2) C_{oss}
- (3) C_{rss}

Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

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30 V P-channel MOSFET with pre-biased NPN transistor

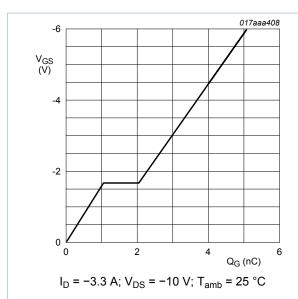


Fig. 14. Gate-source voltage as a function of gate charge; typical values

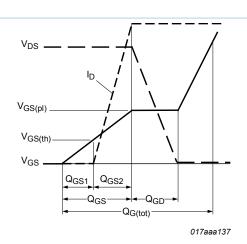
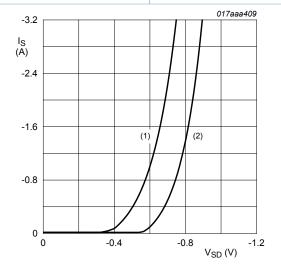


Fig. 15. Gate charge waveform definitions



 $V_{GS} = 0 V$

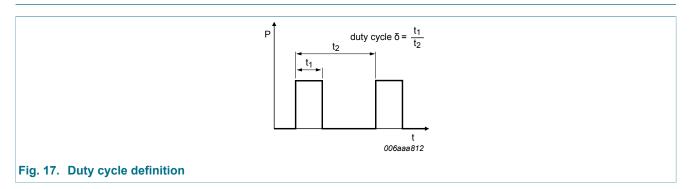
(1) T_{amb} = 150 °C

(2) $T_{amb} = 25 \, ^{\circ}C$

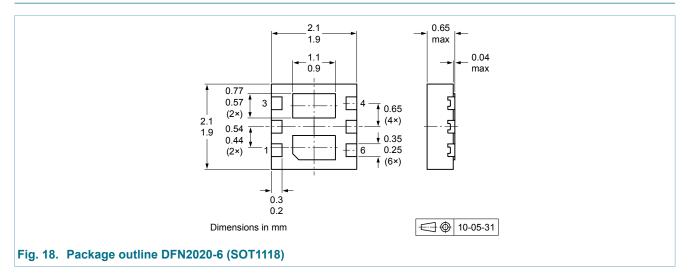
Fig. 16. Source current as a function of source-drain voltage; typical values

30 V P-channel MOSFET with pre-biased NPN transistor

11. Test information

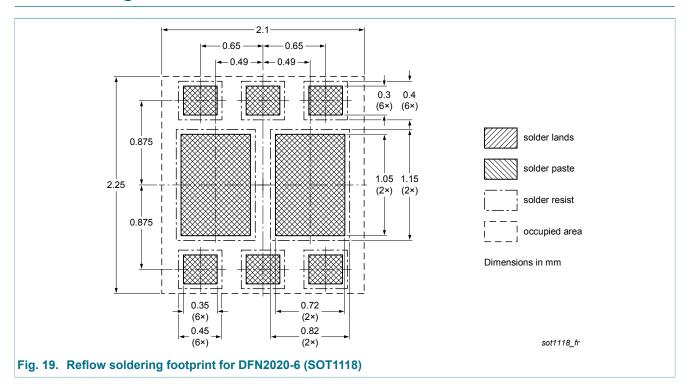


12. Package outline



30 V P-channel MOSFET with pre-biased NPN transistor

13. Soldering



14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
PMC85XP v.2	20130515	Product data sheet	-	PMC85XP v.1		
Modifications:	Pinning information: graphic symbol corrected					
PMC85XP v.1	20120524	Product data sheet	-	-		

30 V P-channel MOSFET with pre-biased NPN transistor

15. Legal information

15.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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30 V P-channel MOSFET with pre-biased NPN transistor

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